IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both nternational and Pan-American copyright conventions.			der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg Information				
upplier Informa	tion								,					
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2025-06-07			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-Steward	ls		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			P	Phone - Representative*				Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Requester l	Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Ianufacturing Site	We	ight*	UOM	Unit Type
	2SB1201S-TL-E BIP PN		BIP PNP 2A 50V	BIP PNP 2A 50V		2025-06-07 CNG		NG	280.84		mg	Each		
	roccess Informatio		amain al Daga	Aller	STD-020 MSL 1	Dating	Dools Droo	aga Dadry To		May Time at Peak	Tomoromotive	Nyamb	er of Reflow Cyc	los
<u> </u>			Terminal Base Alloy J-ST CU Alloy 1		81D-020 MSL I	Kating	Peak Process Body Tempera 260 C						er of Reflow Cyc	ies
			U Alloy	1			200		IC	30	seconds	3		
omments		J	J!	20										
	ne at peak temperature													
For more information	regarding material cor	nposition p	olease refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.33	mg	Supplier	Silicon (Si)	7440-21-3		0.33	mg
Die Attach Solder	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.0038	mg
			A	Lead (Pb)	7439-92-1	7a	0.1388	mg
			Supplier	Tin (Sn)	7440-31-5		0.0075	mg
Lead Frame	146.46	mg	Supplier	Silver (Ag)	7440-22-4		0.3808	mg
			Supplier	Tin (Sn)	7440-31-5		0.205	mg
			Supplier	Copper (Cu)	7440-50-8		145.8742	mg
Mold Compound-Black	130.38	mg		Brominated epoxy resin	proprietary data		1.8253	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		5.8671	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		1.1734	mg
			Supplier	Carbon Black (C)	1333-86-4		1.3038	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		97.785	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		22.1646	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.2608	mg
Plating	3.34	mg	В	Bismuth (Bi)	7440-69-9		0.02	mg
-			Supplier	Tin (Sn)	7440-31-5		3.32	mg
Wire Bond - Au	0.18	mg	Supplier	Gold (Au)	7440-57-5		0.18	mg